503465958 09/03/2015

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3512583

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
TSUNEHIRO NAKAJIMA	08/17/2015

RECEIVING PARTY DATA

Name:	FUJI ELECTRIC CO., LTD.	
Street Address:	1-1 TANABESHINDEN, KAWASAKI-KU,	
City:	KAWASAKI-SHI,	
State/Country:	JAPAN	
Postal Code:	210-9530	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14844647

CORRESPONDENCE DATA

Fax Number: (703)518-5499

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 703-684-1111

Email: office@uspatentagents.com

Correspondent Name: KANESAKA BERNER AND PARTNERS LLP

Address Line 1: 2318 MILL ROAD Address Line 2: SUITE 1400

Address Line 4: ALEXANDRIA, VIRGINIA 22314-2848

ATTORNEY DOCKET NUMBER:	FUJ-264
NAME OF SUBMITTER:	MANABU KANESAKA
SIGNATURE:	/Manabu KANESAKA/
DATE SIGNED:	09/03/2015

Total Attachments: 1

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PATENT 503465958 REEL: 036489 FRAME: 0573

ASSIGNMENT

For value received, I, Tsunehiro NAKAJIMA having post office address at c/o FUJI ELECTRIC CO., LTD., 1-1 Tanabeshinden, Kawasaki-ku, Kawasaki-shi 210-9530, Japan hereby sell, assign and transfer to FUJI ELECTRIC CO., LTD. corporation existing under the laws of Japan located at 1-1 Tanabeshinden, Kawasaki-ku, Kawasaki-shi 210-9530, Japan and its successors, assigns, and legal representatives the entire right, title, and interest for all countries including the United States of America, in and to certain inventions relating to METHOD FOR MANUFACTURING SEMICONDUCTOR DEVICE described in application for Letters Patent of the United States, executed by me on this date, and all patents which may be granted therefor, and all divisions, reissues, continuations and extensions thereof, and authorize and request the Commissioner of Patents and Trademarks to issue all patents on said improvements or resulting therefrom to said Company as assignee of the entire interest, and covenant that I have full right so to do, and agree that I will communicate to said Company or its representatives any facts known to me respecting said improvements and testify in any legal proceedings, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid said Company, its successors, assigns, and nominees, to obtain and enforce proper protection for said invention in the United States.

Signature Jounekiro Makajima Date augusto 17, 2015

Tsunehiro NAKAJIMA

1

PATENT REEL: 036489 FRAME: 0574